



3.3 Volt CMOS 16-Bit Tranceiver

QS74FCT2X3245

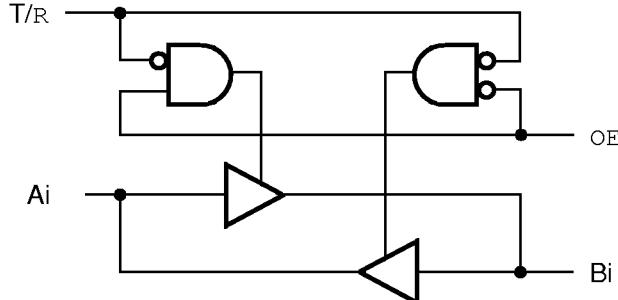
FEATURES/BENEFITS

- Pin and function compatible to the QSFCT2X245
- Available in 40-pin QVSOP
- Undershoot clamp diodes on all inputs
- Ground bounce controlled outputs
- Low power QCMOS: 0.07 μ W typ static
- JEDEC low voltage spec compatible
- $I_{OL} = 24$ mA Com.
- TTL-compatible input and output levels
- Extended temperature -40°C to $+85^{\circ}\text{C}$
- 2.7V to 3.6V Supply Voltage

DESCRIPTION

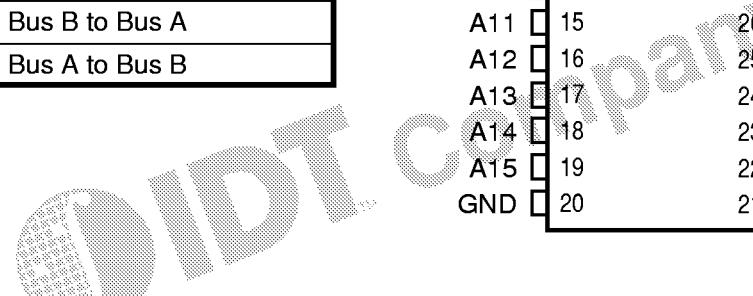
The FCT2X3245 is a 16-bit non-inverting transceiver that has three-state outputs which are useful for bus-oriented applications. The Transmit/Receive (T/R) input determines the direction of data flow, either from A-to-B or B-to-A, and Output Enable (\overline{OE}) input enables the selected port for output. All inputs have clamp diodes for undershoot noise suppression and all outputs have ground bounce suppression (see QSI Application Note AN-001). Control pins can be driven by 3.3V or 5V components. Ultra-low power QCMOS technology makes this product ideal for portable computing systems or communications devices.

FUNCTIONAL BLOCK DIAGRAM



PIN DESCRIPTION

Name	I/O	Description
Ai	I/O	Data Bus A
Bi	I/O	Data Bus B
T/R0	I	Direction A7-A0 ↔ B7-B0
T/R1	I	Direction A15-A8 ↔ B15-B8
OE0	I	Output Enable A7-A0 ↔ B7-B0
OE1	I	Output Enable A15-A8 ↔ B15-B8

**PIN CONFIGURATION
(All Pins Top View)**


T/R0	1	40	Vcc
A0	2	39	OE0
A1	3	38	B0
A2	4	37	B1
A3	5	36	B2
A4	6	35	B3
A5	7	34	B4
A6	8	33	B5
A7	9	32	B6
GND	10	31	B7
T/R1	11	30	Vcc
A8	12	29	OE1
A9	13	28	B8
A10	14	27	B9
A11	15	26	B10
A12	16	25	B11
A13	17	24	B12
A14	18	23	B13
A15	19	22	B14
GND	20	21	B15

FUNCTION TABLE

OE	T/R	A	B	Function
H	X	Hi-Z	Hi-Z	Disable
L	L	Output	Input	Bus B to Bus A
L	H	Input	Output	Bus A to Bus B

ABSOLUTE MAXIMUM RATINGS

Supply Voltage to Ground	-0.5V to +4.6V
DC Input/Output Voltage	-0.5V to Vcc + 0.5V
DC Control Pin Voltage V _{IN}	-0.5V to +7.0V
AC Input Voltage (for a pulse width ≤ 20 ns)	-3.0V
DC Input Diode Current with V _{IN} < 0	±20 mA
DC Output Diode Current with V _{OUT} < 0	±50 mA
DC Output Current Max. Sink Current/Pin	±60 mA
Maximum Power Dissipation	0.5 watts
T _{STG} Storage Temperature	-65° to +150°C

Note: Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to this device resulting in functional or reliability type failures.

CAPACITANCE

T_A = 25°C, f = 1 MHz, V_{IN} = 0V, V_{OUT} = 0V

Pins	QVSOP	Unit
1, 11, 29, 39	4	pF
2-9,12-19, 21-28, 31-38	8	pF

Note: Capacitance is characterized but not tested.

RECOMMENDED OPERATING CONDITIONS

Symbol	Description	Min	Max	Unit
V _{CC}	Supply Voltage	2.7	3.6	V
V _{IN}	Input Voltage	0	V _{CC}	V
V _{OUT}	Output Voltage	0	V _{CC}	V
T _A	Ambient Operating Temperature	-40	+85	°C
Δt/ΔV	Input Transition Rise or Fall Rate ⁽¹⁾	0	8	ns/V

Notes:

- As measured between 0.8V and 2V.

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Recommended operating conditions apply unless otherwise specified.

Symbol	Parameter	Test Conditions	Min	Typ ⁽¹⁾	Max	Unit
V _{IH}	Input HIGH Voltage	Input Pins	2.0	—	5.5	V
		I/O Pins	2.0	—	V _{CC} +0.5	V
V _{IL}	Input LOW Voltage	Input Pins	-0.5	—	0.8	V
ΔV _T	Input Hysteresis	V _{TLH} - V _{THL} for All Inputs	—	0.2	—	V
I _{IH} I _{IL}	Input Current Input HIGH or LOW	V _{CC} = Max., 0 ≤ V _{IN} < V _{CC}	—	—	1	μA
I _{OZ}	Off-State Output Current (Hi-Z)	V _{CC} = Max., 0 ≤ V _{IN} ≤ V _{CC}	—	—	5	μA
I _{OS}	Short Circuit Current	V _{CC} = Max., V _{OUT} = GND ^(2,3)	-60	—	-225	mA
V _{IC}	Input Clamp Voltage	V _{CC} = Min., I _{IN} = -18 mA ⁽³⁾	—	-0.7	—	V
V _{OH}	Output HIGH Voltage	V _I = V _{IH} or V _{IL} , V _{CC} = Min., I _{OH} = -100 μA	V _{CC} -0.2	—	—	V
		V _I = V _{IH} or V _{IL} , V _{CC} = 3V, I _{OH} = -8 mA	2.4	—	—	V
V _{OL}	Output LOW Voltage	V _I = V _{IH} or V _{IL} , V _{CC} = Min., I _{OL} = 100 μA	—	—	0.2	V
		V _I = V _{IH} or V _{IL} , V _{CC} = 3V, I _{OL} = 16 mA	—	—	0.4	V
		V _I = V _{IH} or V _{IL} , V _{CC} = 3V, I _{OL} = 24 mA	—	—	0.5	V

Notes:

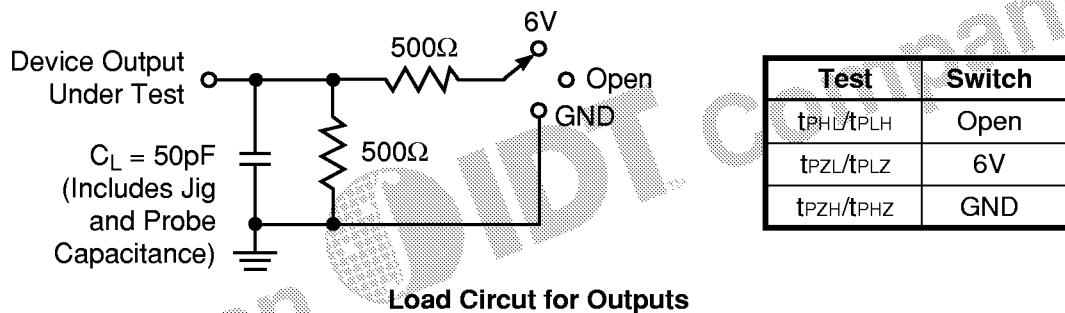
- Typical values indicate V_{CC} = 3.3V and T_A = 25°C.
- Not more than one output should be shorted and the duration is ≤1 second.
- These parameters are guaranteed by design but not tested.

POWER SUPPLY CHARACTERISTICS

Symbol	Parameter	Test Conditions ⁽¹⁾	Min	Typ	Max	Unit
I _{CC}	Quiescent Power Supply Current	V _{CC} = Max., freq = 0 0V ≤ V _{IN} ≤ 0.2V or V _{CC} -0.2V ≤ V _{IN} ≤ V _{CC}	—	0.02	40	µA
ΔI _{CC}	Supply Current per Input @ TTL HIGH	V _{CC} = Max., freq = 0, V _{IN} = V _{CC} - 0.6V	—	1.0	20	µA
Q _{CCD}	Supply Current per Input per MHz	V _{CC} = Max., Outputs Open and Enabled One Bit Toggling @ 50% Duty Cycle Other Inputs at GND or V _{CC} ^(2,3)	—	40	85	µA/MHz

Notes:

- For conditions shown as Min. or Max., use the appropriate values specified under DC specifications.
- Q_{CCD} is a measurement of device power consumption only and does not include power to drive load capacitance or tester capacitance. This parameter is guaranteed by design but not tested.
- I_C can be computed using the above parameters as explained in the Technical Overview section.

**Notes**

- Input pulse characteristics: 0V to 2.7V, tr = tf = 2.5 ns (10% to 90%), transition measured at 1.5V, pulse generator Z_{OUT} = 50Ω.

SWITCHING CHARACTERISTICS OVER OPERATING RANGE

Commercial TA = 0°C to 70°C, V_{CC} = 3.3V ± 0.3VC_{LOAD} = 50 pF, R_{LOAD} = 500Ω unless otherwise noted.

Symbol	Description ⁽¹⁾	2X3245		2X3245A		Unit
		Min	Max	Min	Max	
t _{PLH}	Propagation Delay Ai to Bi	1.5	7	1.5	4.6	ns
t _{PZH}	Output Enable OE, T/R to A/B	1.5	9.5	1.5	6.2	ns
t _{PLZ}	Disable Time ⁽²⁾	1.5	7.5	1.5	5	ns

Notes:

- Minimums are guaranteed but not tested.
- This parameter is guaranteed by design but not tested.
- See Test Circuit and Waveforms.